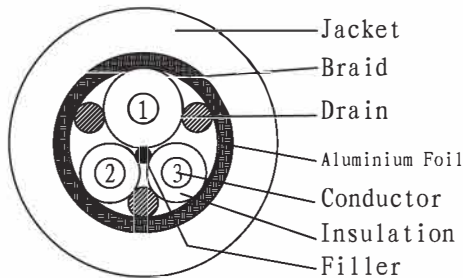
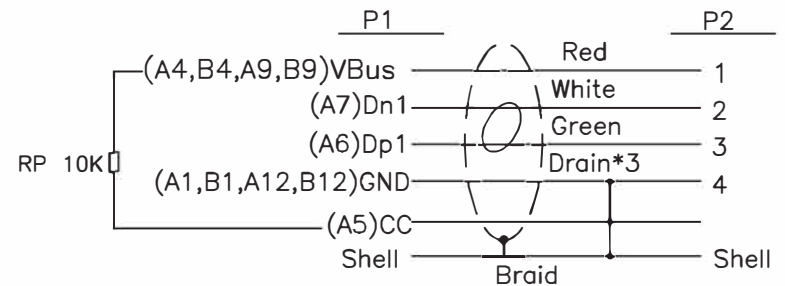


**Electrical Test:**

1. 100%Test(Open ,short ,miss wire)
2. Contact Resistance: 2 ohm max.
3. Insulation Resistance: 10M ohm Min.
4. Hi-Pot: 300VDC/10ms.



**Pin Assignment**



11	USB TYPE C~Under the tinplate plating nickel	1	pcs
10	USB TYPE C~On the tinplate plating nickel	1	pcs
9	W=5MM 25u copper foil	0.012	M
8	H.S TUBE $\phi$ 1.0 Color:Black	0.016	M
7	45P PVC Color:Black	16	g
6	Transparent PE	8	g
5	USB2.0 C TYPE Connector With PCBA(Resistance10K $\Omega$ )	1	pcs
4	USB2.0 AM Front Shell Nickel Plated Shell	1	pcs
3	USB2.0 AM Back Shell Nickel Plated Shell	1	pcs
2	USB2.0 AM Solder White Insulation	1	pcs
1	NO~UL~30AWG (19/0.06TC)*2C+22AWG (41/0.10TC+250D)*1C+E (19/0.05TC+250D)*3+AB (16/9/0.06TC)95%TC~OD:3.2MM~Color:Black NO Marking	2	M
NO	<b>DESCRIPTION</b>	<b>Q'TY</b>	<b>UNIT</b>

REV.	DESCRIPTION		DATE
	<b>TOLERANCE</b> INCHES M/M		<b>BTX Technologies, Inc.</b>   <a href="http://www.btx.com">www.btx.com</a>
	.X	.015 .30	
	.XX .XXX	.010 .10 .005 .05	
DRAWN BY		CUSTOMER :	
CHECK BY		CUSTOMER P/N :	
APPD BY		SCALE	NONE
		UNIT	mm
		DATE	2015.07.06
		DRAWING NO.:	REV. A01
			1/1